

2N6430 2N6431

CASE 22, STYLE 1
TO-18 (TO-206AA)

GENERAL PURPOSE
TRANSISTOR

NPN SILICON

4

MAXIMUM RATINGS

Rating	Symbol	2N6430	2N6431	Unit
Collector-Emitter Voltage	V_{CE0}	200	300	Vdc
Collector-Base Voltage	V_{CB0}	200	300	Vdc
Emitter-Base Voltage	V_{EBO}	6.0		Vdc
Collector Current — Continuous	I_C	50		mA
Total Device Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	500	2.86	mW mW/°C
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	1.8	10.3	Watts mW/°C
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-65 to +200		°C

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector-Emitter Breakdown Voltage(1) ($I_C = 1.0$ mAdc, $I_B = 0$)	$V_{(BR)CEO}$	200 300	— —	Vdc
Collector-Base Breakdown Voltage ($I_C = 0.1$ mAdc, $I_E = 0$)	$V_{(BR)CBO}$	200 300	— —	Vdc
Emitter-Base Breakdown Voltage ($I_E = 0.1$ mAdc, $I_C = 0$)	$V_{(BR)EBO}$	6.0	—	Vdc
Collector Cutoff Current ($V_{CB} = 160$ Vdc) ($V_{CB} = 200$ Vdc)	I_{CBO}	— —	0.1 0.1	μA dc
Emitter Cutoff Current ($V_{EB} = 4.0$ Vdc, $I_C = 0$)	I_{EBO}	—	0.1	μA dc
ON CHARACTERISTICS				
DC Current Gain ($I_C = 1.0$ mAdc, $V_{CE} = 10$ Vdc) ($I_C = 10$ mAdc, $V_{CE} = 10$ Vdc) ($I_C = 30$ mAdc, $V_{CE} = 10$ Vdc)	h_{FE}	25 40 50	— — 200	—
Collector-Emitter Saturation Voltage ($I_C = 20$ mAdc, $I_B = 2.0$ mAdc)	$V_{CE(sat)}$	—	0.5	Vdc
Base-Emitter Saturation Voltage ($I_C = 20$ mAdc, $I_B = 2.0$ mAdc)	$V_{BE(sat)}$	—	0.9	Vdc
SMALL-SIGNAL CHARACTERISTICS				
Current-Gain — Bandwidth Product ($I_C = 10$ mAdc, $V_{CE} = 20$ Vdc, $f = 100$ MHz)	f_T	50	500	MHz
Collector-Base Capacitance ($V_{CB} = 20$ Vdc, $I_E = 0$, $f = 1.0$ MHz)	C_{cb}	—	4.0	pF

(1) Pulse Test: Pulse Width $\leq 300 \mu\text{s}$, Duty Cycle $\leq 2.0\%$.